

**描述 / Descriptions**

DFN0603 塑封封装单线程双向 ESD 保护二极管。

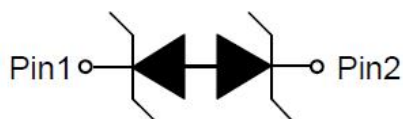
DFN0603 Plastic Package 1-Line,Bi-directional , ESD Protection Diode.

特征 / Features

- ◆ Stand-off voltage: $\pm 12\text{V}$ Max.
- ◆ Transient protection for each line according to
 - IEC61000-4-2(ESD): $\pm 30\text{kV}$ (contact)
 - IEC61000-4-4 (EFT): 40A (5/50ns)
 - IEC61000-4-5(surge): 6A (8/20 μs)
- ◆ Ultra-low capacitance: $C_J = 5\text{pF}$ typ.
- ◆ Low leakage current:
- ◆ Low clamping voltage: $V_{CL} = 21.0\text{V}$ typ. @ $I_{PP} = 16\text{A}$ (TLP)
- ◆ Solid-state silicon technology
- ◆ HF Product

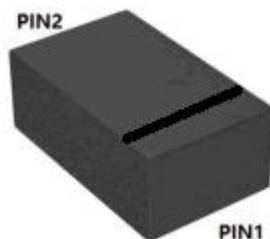
用途 / Applications

- ◆ Computers and peripherals
- ◆ Audio and video equipment
- ◆ Communication systems
- ◆ Portable electronics

内部等效电路 / Equivalent Circuit



引脚排列 / Pinning

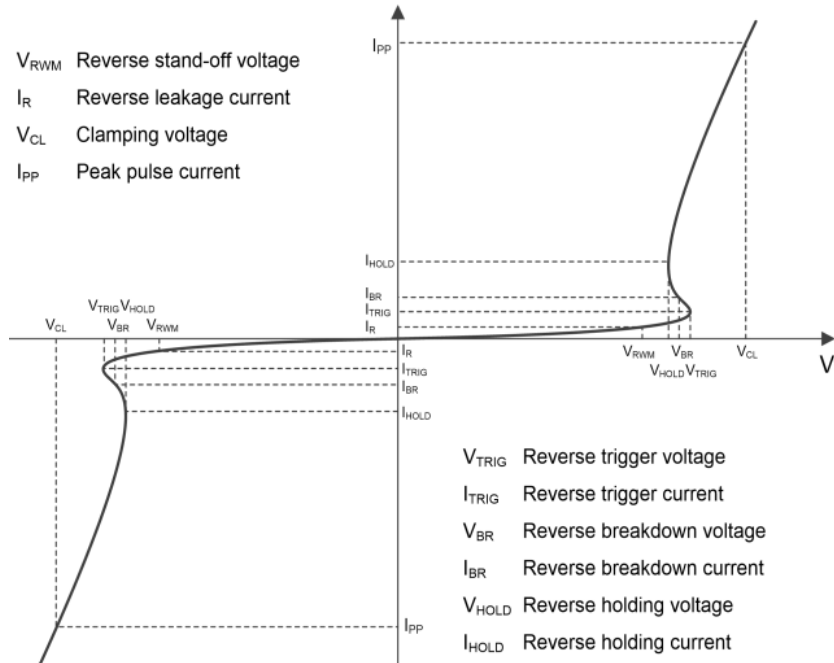
放大及印章代码 / h_{FE} Classifications & Marking

见印章说明。See Marking Instructions.

极限参数 / Absolute Maximum Ratings

参数 Parameter	符号 Symbol	数值 Rating	单位 Unit
Peak Pulse Power($t_p = 8/20\mu s$)	P_{PK}	120	W
Peak Pulse Current($t_p = 8/20\mu s$)	I_{PP}	6	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 30	KV
ESD according to IEC61000-4-2 contact discharge		± 30	
Junction temperature	T_J	125	°C
Operating temperature	T_{OP}	-40~85	°C
Lead temperature	T_L	260	°C
Storage Temperature	T_{STG}	-55~+150	°C

电性能参数 / Electrical Characteristics(Ta=25°C)



Definitions of electrical characteristics

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Reverse maximum working voltage	V_{RWM}				±12	V
Reverse leakage current	I_R	$V_{RWM} = 12V$			100	nA
Reverse breakdown voltage	V_{BR}	$I_{BR}=1mA$	13	14		V
Reverse holding voltage	V_{HOLD}	$I_{HOLD}=50mA$	13	14		V
Clamping voltage ¹⁾	V_{CL}	$I_{PP}=16A \quad t_p=100ns$		21.0		V
Dynamic resistance ¹⁾	R_{DYN}			0.35		Ω
Clamping voltage ²⁾	V_{CL}	$V_{ESD}= 8kV$		21.0		V
Clamping voltage ³⁾	V_{CL}	$I_{PP} = 1A \quad t_p = 8/20\mu s$		14	16	V
		$I_{PP} = 6A \quad t_p = 8/20\mu s$		18.5	20	V
Junction Capacitance	C_J	$V_R = 0V \quad f = 1MHz$		5	7	pF
	C_J	$V_R = 2.5V \quad f = 1MHz$		4	6	pF

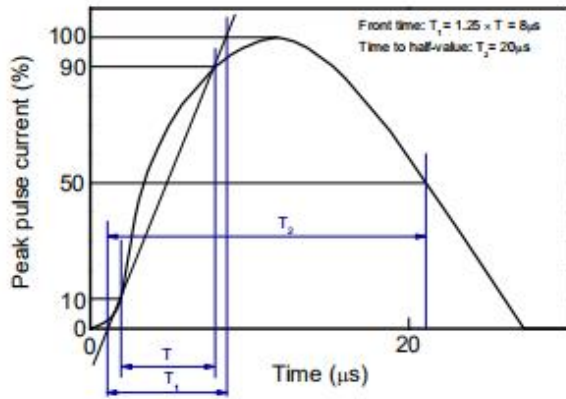
Notes:

1) TLP parameter: $Z_0 = 50\Omega$, $t_p = 100ns$, $t_r = 2ns$, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.

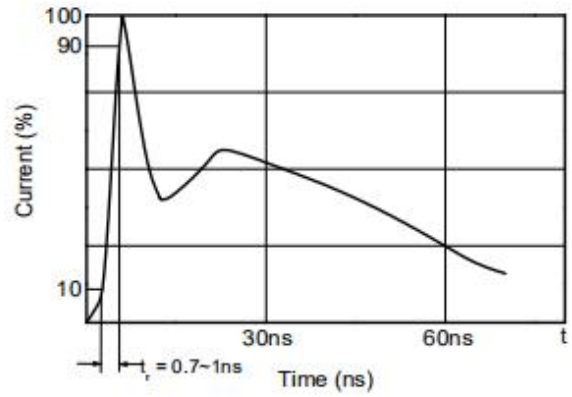
2) Contact discharge mode, according to IEC61000-4-2.

3) Non-repetitive current pulse, according to IEC61000-4-5.

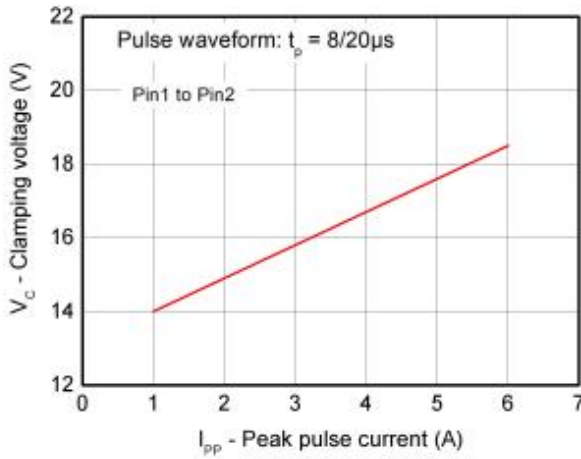
电参数曲线图 / Electrical Characteristic Curve($T_a=25^\circ\text{C}$)



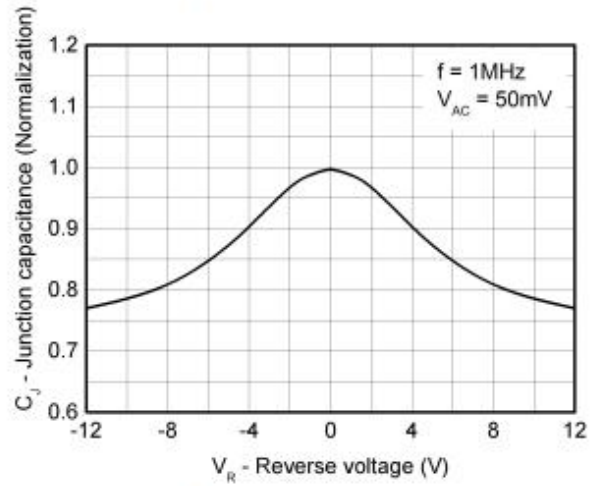
8/20 μs waveform per IEC61000-4-5



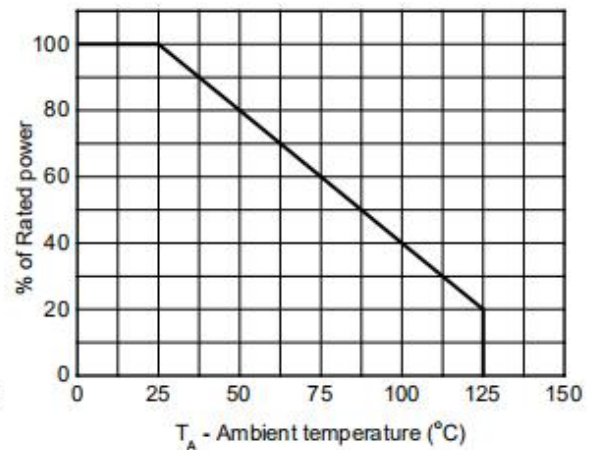
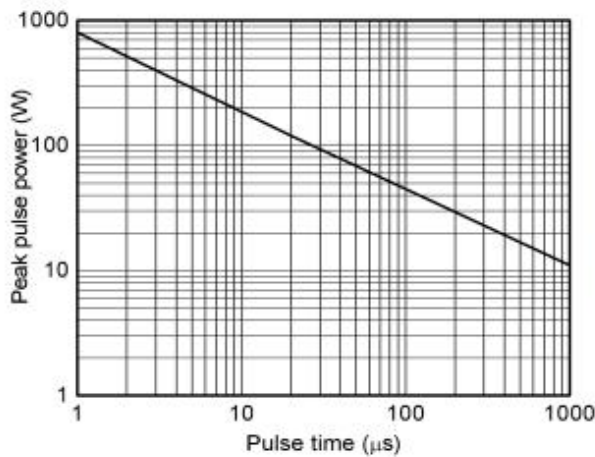
Contact discharge current waveform per IEC61000-4-2



Clamping voltage vs. Peak pulse current

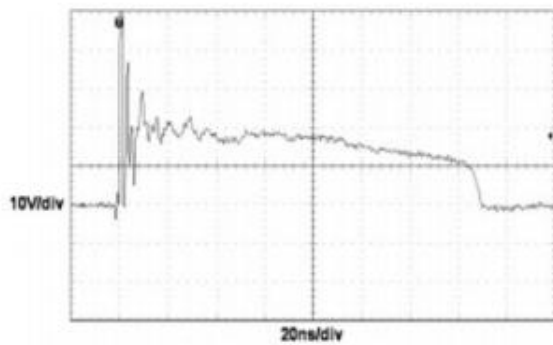


Capacitance vs. Reverse voltage



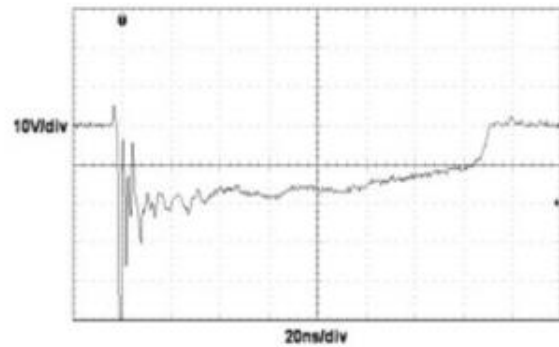


电参数曲线图 / Electrical Characteristic Curve(Ta=25°C)



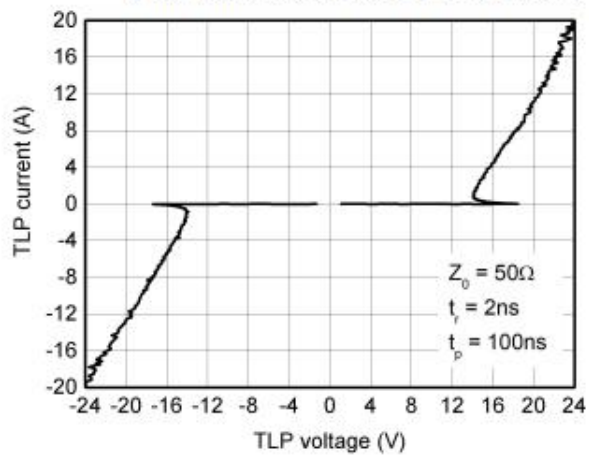
ESD clamping

(+8kV contact discharge per IEC61000-4-2)



ESD clamping

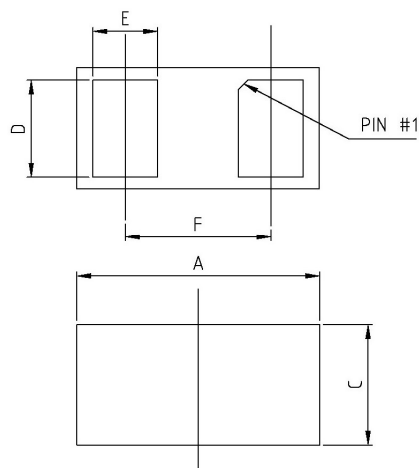
(-8kV contact discharge per IEC61000-4-2)



TLP Measurement

DFN0603-2L

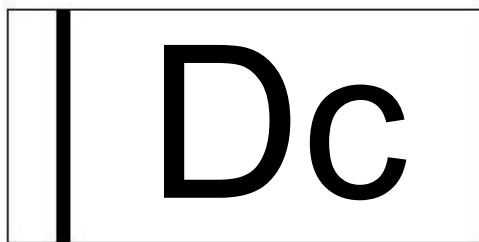
Unit:mm



Dimensions In Millimeterer			
Symbol	MIN	TYP	MAX
A	0.58	0.60	0.65
B	0.28	0.30	0.35
C	0.28	0.30	0.34
D	0.20	0.24	0.26
E	0.13	0.16	0.19
F	-	0.36	-



印章说明 / Marking Instructions



说明：

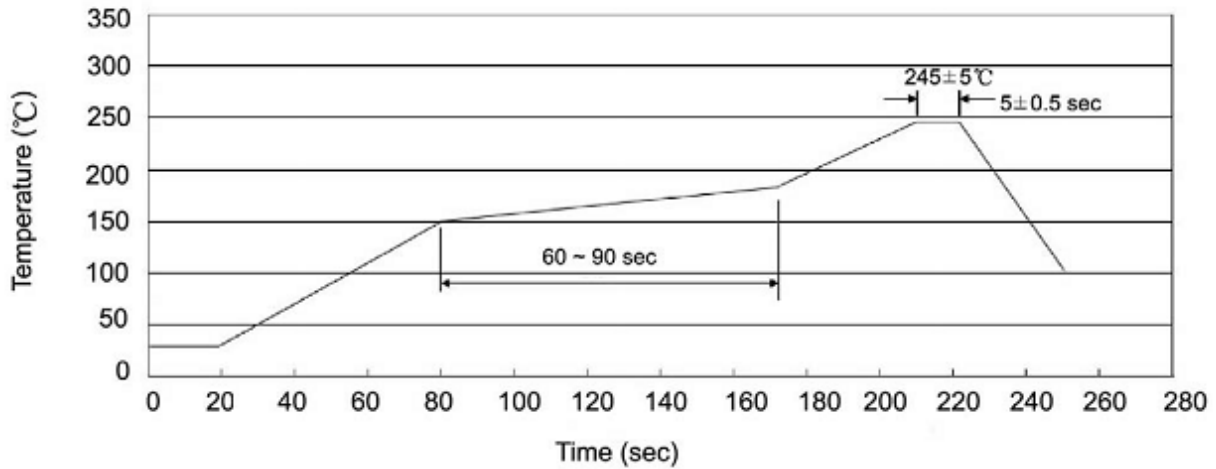
Dc：为型号代码

*：为生产批号代码，随生产批号变化

Note：

Dc：Product Type.

*：Lot No. Code,code change with Lot No.

回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)


说明：

- 1、预热温度 150 ~ 180°C，时间 60 ~ 90sec;
- 2、峰值温度 245±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2 ~ 10°C/sec.

Note:

- 1.Preheating:150~180°C, Time:60~90sec.
- 2.Peak Temp.:245±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度：260±5°C

时间：10±1 sec.

Temp.:260±5°C

Time:10±1 sec

包装规格 / Packaging SPEC.

卷盘包装 / REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
DFN0603-2L	10,000	10	100,000	6	600,000	7" x8	180×120×180	390×385×205

使用说明 / Notices